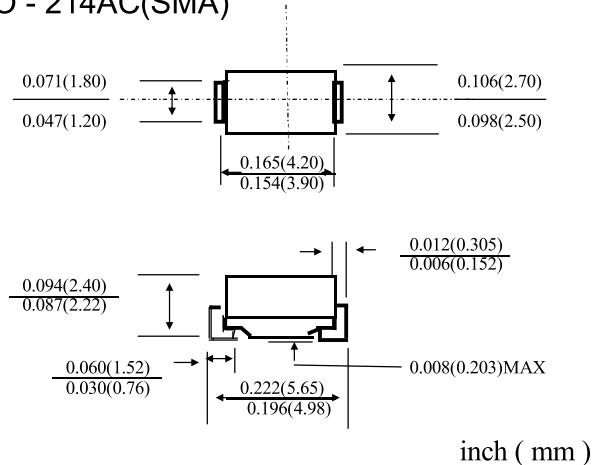




■ 外形尺寸和印记 **Outline Dimensions and Mark**
DO - 214AC(SMA)



■ 特征 **Features**

- I_o 1.0A
- V_{RRM} 50V-600V
- 耐正向浪涌电流能力高
High surge current capability
- 封装: 模压塑料
Cases: Molded plastic

■ 用途 **Applications**

- 整流用 Rectifier

■ 极限值 (绝对最大额定值)

Absolute Maximum Rating

参数名称 Item	符号 Symbol	单位 Unit	测试条件 Test Conditions	ES1							
				A	B	C	D	E	G	H	J
反向重复峰值电压 Repetitive Peak Reverse Voltage	V_{RRM}	V		50	100	150	200	300	400	500	600
正向平均电流 Average Forward Current	$I_{F(AV)}$	A	正弦半波 60Hz, 电阻负载, $T_a=50^\circ C$ 60Hz Half-sine wave, Resistance load, $T_a=50^\circ C$								1.0
正向(不重复)浪涌电流 Surge(Non-repetitive)Forward Current	I_{FSM}	A	正弦半波 60Hz, 一个周期, $T_a=25^\circ C$ 60Hz Half-sine wave, 1 cycle, $T_a = 25^\circ C$								30
结温 Junction Temperature	T_J	°C									-55~+125
储存温度 Storage Temperature	T_{STG}	°C									-55 ~ +150

■ 电特性 ($T_a=25^\circ C$ 除非另有规定)

Electrical Characteristics ($T_a=25^\circ C$ Unless otherwise specified)

参数名称 Item	符号 Symbol	单位 Unit	测试条件 Test Condition	ES1							
				A	B	C	D	E	G	H	J
正向峰值电压 Peak Forward Voltage	V_F	V	$I_F=1.0A$								
最大反向恢复时间 Maximum reverse recovery time	t_{rr}	ns	$I_F=0.5A, I_R=1.0A, I_r=0.25A$								
反向漏电流 Peak Reverse Current	I_{RRM1} I_{RRM2}	μA	$V_{RM}=V_{RRM}$	$T_a=25^\circ C$							
				$T_a=100^\circ C$							
热阻(典型) Thermal Resistance(Typical)	$R_{\theta J-A}$ $R_{\theta J-L}$	°C/W	结和环境之间 Between junction and ambient								
			结和终端之间 Between junction and terminal								

备注: **Notes:**

1) 热阻从结到环境及从结到引线, 在电路板的0.2" x 0.2" (5.0毫米 x 5.0毫米)铜垫片区

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

特性曲线(典型)

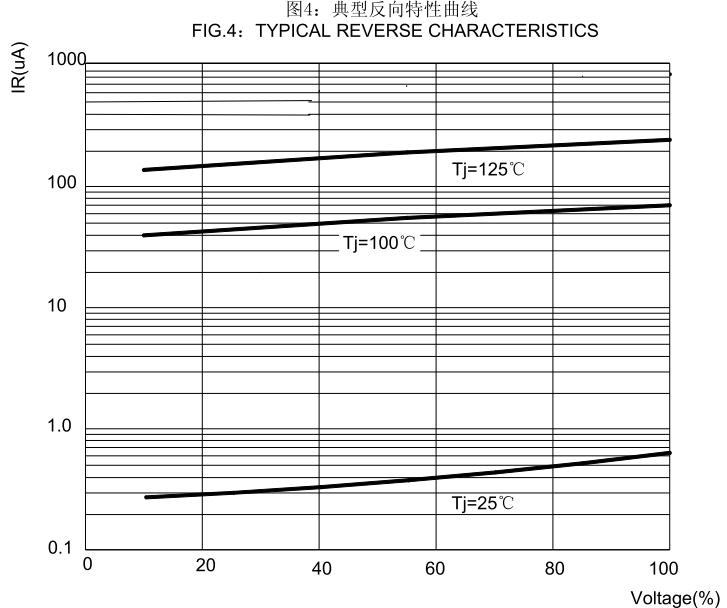
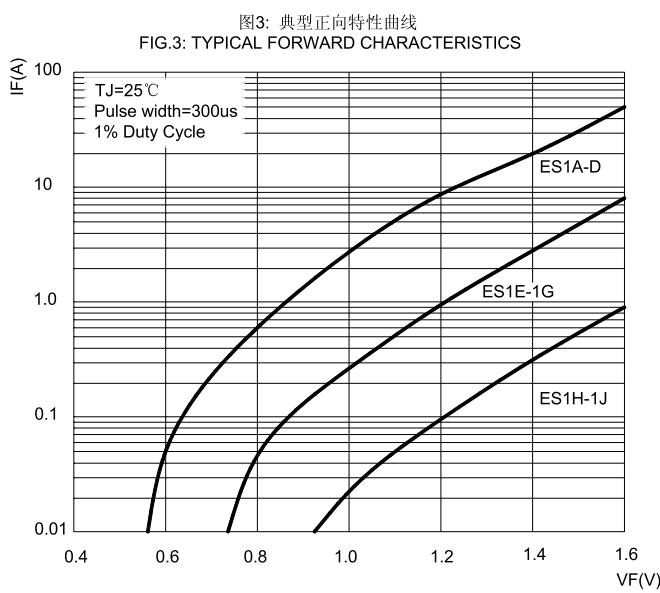
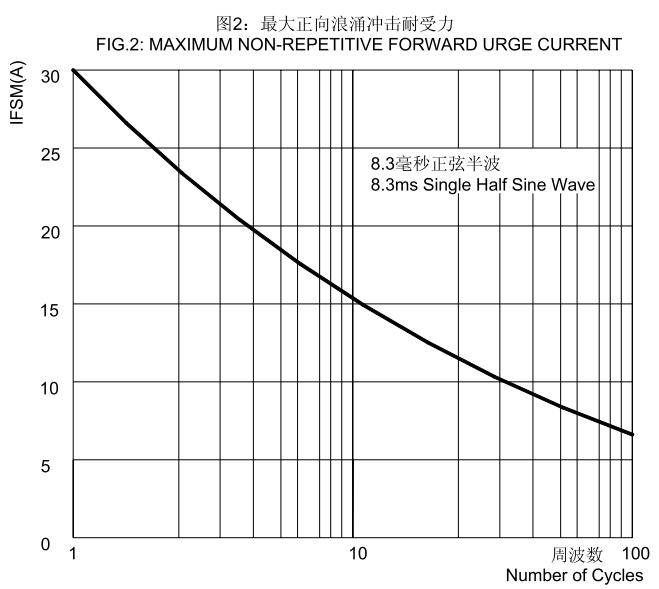
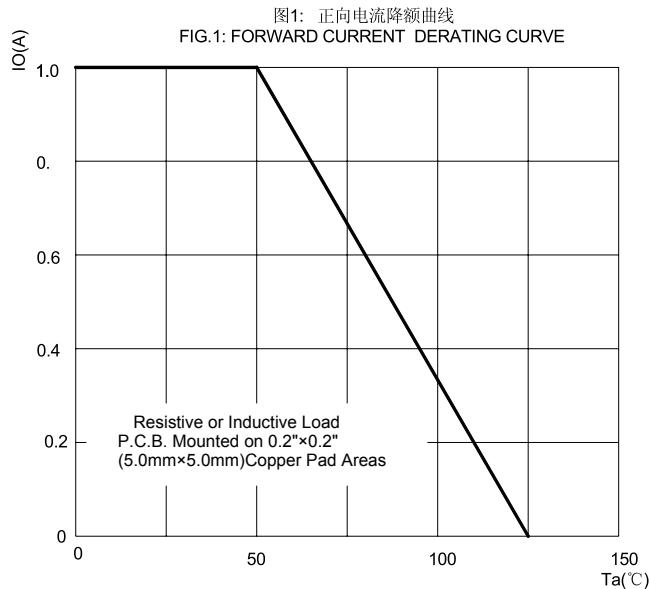


图5: 反向恢复时间试验电路及测试波形示意图
FIG.5: Diagram of circuit and Testing wave form of reverse recovery time

